

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT3960662

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
KON-WOO KWON	06/29/2016
VIVEK KOZHIKOTTU	06/29/2016
DINESH SOMASEKHAR	06/29/2016
RECEIVING PARTY DATA	
Name:	INTEL CORPORATION
Street Address:	2200 MISSION COLLEGE BOULEVARD
City:	SANTA CLARA
State/Country:	CALIFORNIA
Postal Code:	95054
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15197590
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Email:	rachel_townsend@bstz.com
Correspondent Name:	MARK C. VAN NESS
Address Line 1:	1279 OAKMEAD PARKWAY
Address Line 4:	SUNNYVALE, CALIFORNIA 94085-4040
ATTORNEY DOCKET NUMBER:	42P97055
NAME OF SUBMITTER:	MARK C. VAN NESS
SIGNATURE:	/Mark C. Van Ness/
DATE SIGNED:	07/13/2016
Total Attachments: 2	
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source=assignment_signed#page2.tif	

ASSIGNMENT

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, we, the undersigned inventor(s):

Kon-Woo KWON; Vivek KOZHIKOTTU; Dinesh SOMASEKHAR

hereby sell, assign, and transfer to

Intel Corporation

a corporation of Delaware, having a principal place of business at 2200 Mission College Boulevard, Santa Clara, California, 95054 USA ("Assignee"), and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States and all other countries, in and to any and all inventions and improvements that are disclosed in the application for the patent entitled:

LOW-OVERHEAD MECHANISM TO DETECT ADDRESS FAULTS IN ECC-PROTECTED MEMORIES

(I hereby authorize and request any attorney having appropriate authority from the assignee to insert on the designated lines below, the filing date and application number of said application when known.)

which was filed on June 29, 2016 as


United States Application Number 15/197,590 and

which has been executed by the undersigned prior hereto or concurrently herewith on the date(s) indicated below,

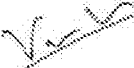
and in and to said application and all Additional Applications, and all other patent applications that have been or shall be filed in the United States and all other countries and international filing offices on any of said inventions and improvements; and in and to all original and reissued patents that have been or shall be issued in the United States and all other countries and international filing offices on said inventions and improvements; and in and to all rights of priority resulting from the filing of said applications; as used herein "Additional Applications" includes but is not limited to design, utility, utility model, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and national phase applications on said inventions and improvements;

and agree that said Assignee may apply for and receive a patent or patents for said inventions and improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all Additional Applications, and all other patent applications on any and all said inventions and improvements; execute all rightful oaths, assignments, powers of attorney, and other papers; communicate to said Assignee, its successors, assigns, and legal representatives all facts known to the undersigned relating to said inventions and improvements and the history thereof; and generally assist said Assignee, its successors, assigns, or legal representatives in securing and maintaining proper patent protection for said inventions and improvements and for vesting title to said inventions and improvements, and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

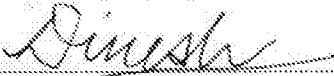
covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.


Inventor 1: **Kon-Woo KWON**

6/29/2016
Date Signed


Inventor 2: **Vivek KOZHIKOTTU**

6/29/2016
Date Signed


Inventor 3: **Dinesh SOMASEKHAR**

6/29/2016
Date Signed

Inventor 4:

Date Signed

Inventor 5:

Date Signed

Inventor 6:

Date Signed

Inventor 7:

Date Signed

Inventor 8:

Date Signed

Inventor 9:

Date Signed

Inventor 10:

Date Signed

Inventor 11:

Date Signed

Inventor 12:

Date Signed